

L Number	Hits	Search Text	DB	Time stamp
-	36415	(thermal adj interface) or (phase adj change)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:34
-	1	((thermal adj interface) or (phase adj change)) and (filler near fusible)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/18 18:25
-	1	(thermal adj interface) and (phase adj change adj polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:44
-	93	(phase adj change) near polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:28
-	2	((phase adj change) near polymer) and (thermal adj interface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:28
-	55	(thermal adj interface) and (phase adj change) and filler	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:45
-	2	(thermal adj interface) and (phase adj change) and (fusible near filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:13
-	44	(thermal adj interface adj material) and (phase adj change) and filler	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:47
-	20	(lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:14
-	37657	(thermal adj interface) or (phase adj change)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:14
-	2	((lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)) and ((thermal adj interface) or (phase adj change))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:18
-	6	((lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)) and phase	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:19

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-	20	(lead or cadmium or mercury, antimony or arsenic) and (fusible near filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:28
-	37735	(thermal adj interface) or (phase adj change)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:34
-	315	Jayaraman.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	2306	Konig.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	237	Dani.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	2852	Jayaraman.IN. or Konig.IN. or Dani.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	10	(Jayaraman.IN. or Konig.IN. or Dani.IN.) and ((thermal adj interface) or (phase adj change))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 11:41
-	3304	(428/323).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	583	(428/673).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	2201	(428/402).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	296	(428/645).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	1220	(524/432).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:38
-	1519	(524/495).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:38

-	1224	(524/437).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:38
-	9951	((428/323).CCLS.) or ((428/673).CCLS.) or ((428/402).CCLS.) or ((428/645).CCLS.) or ((524/432).CCLS.) or ((524/495).CCLS.) or ((524/437).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:39
-	87	((428/323).CCLS.) or ((428/673).CCLS.) or ((428/402).CCLS.) or ((428/645).CCLS.) or ((524/432).CCLS.) or ((524/495).CCLS.) or ((524/437).CCLS.)) and ((thermal adj interface) or (phase adj change))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 11:41
-	23	((428/323).CCLS.) or ((428/673).CCLS.) or ((428/402).CCLS.) or ((428/645).CCLS.) or ((524/432).CCLS.) or ((524/495).CCLS.) or ((524/437).CCLS.)) and ((thermal adj interface) or (phase adj change)) and (fusible or melted)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 11:42